## 256K(32K x 8) Static RAM

## Features

- Single 3.3V power supply
- Ideal for low-voltage cache memory applications
- High speed
- 10/12/15 ns
- Low active power
- 216 mW (max.)
- Low-power alpha immune 6T cell
- Plastic SOJ and TSOP packaging


## Functional Description ${ }^{[1]}$

The CY7C1399B is a high-performance 3.3V CMOS Static RAM organized as 32,768 words by 8 bits. Easy memory expansion is provided by an active LOW Chip Enable (CE) and
active LOW Output Enable ( $\overline{\mathrm{OE}}$ ) and three-state drivers. The device has an automatic power-down feature, reducing the power consumption by more than 95\% when deselected.
An active LOW Write Enable signal ( $\overline{\mathrm{WE}}$ ) controls the writing/reading operation of the memory. When CE and WE inputs are both LOW, data on the eight data input/output pins ( $/ / \mathrm{O}_{0}$ through $I / \mathrm{O}_{7}$ ) is written into the memory location addressed by the address present on the address pins ( $\mathrm{A}_{0}$ through $\mathrm{A}_{14}$ ). Reading the device is accomplished by selecting the device and enabling the outputs, $\overline{\mathrm{CE}}$ and $\overline{\mathrm{OE}}$ active LOW, while $\overline{\text { WE }}$ remains inactive or HIGH. Under these conditions, the contents of the location addressed by the information on address pins is present on the eight data input/output pins.
The input/output pins remain in a high-impedance state unless the chip is selected, outputs are enabled, and Write Enable (WE) is HIGH. The CY7C1399B is available in 28-pin standard 300-mil-wide SOJ and TSOP Type I packages.


## Selection Guide

|  | 1399B-10 | 1399B-12 | 1399B-15 | 1399B-20 | Unit |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Access Time | 10 | 12 | 15 | 20 | ns |  |
| Maximum Operating Current | 60 | 55 | 50 | 45 | mA |  |
| Maximum CMOS Standby Current |  | 500 | 500 | 500 | 500 | $\mu \mathrm{~A}$ |
|  | L | 50 | 50 | 50 | 50 | $\mu \mathrm{~A}$ |

Note:

1. For guidelines on SRAM system design, please refer to the 'System Design Guidelines' Cypress application note, available on the internet at www.cypress.com.

## Pin Configuration

| TSOP Top View |  |  |
| :---: | :---: | :---: |
| $\overline{\mathrm{OE}} \square^{22}$ |  | ${ }^{21}$ ] $\mathrm{A}_{0}$ |
| $\mathrm{A}_{1}{ }_{23}$ |  |  |
| $\mathrm{A}_{2}{ }^{24}$ |  | ${ }_{19}{ }^{1 / 1 / O_{7}}$ |
| $\mathrm{A}_{3}{ }^{\text {a }}$ |  | ${ }_{18} \mathrm{I} / \mathrm{O}_{6}$ |
| $\mathrm{A}_{4}{ }^{26}$ |  | ${ }_{17} \mathrm{I} / \mathrm{O}_{5}$ |
| WES 27 |  | ${ }_{16} \mathrm{I} / \mathrm{O}_{4}$ |
|  |  | ${ }_{15} \mathrm{I} / \mathrm{O}_{3}$ |
| $\mathrm{A}_{5} \mathrm{C}_{1}$ |  | 14 GND |
| $\mathrm{A}_{6}$ |  | ${ }_{13} \mathrm{I} / \mathrm{O}_{2}$ |
| A7 ${ }^{\text {a }}$ |  | ${ }_{12} \mathrm{l} / \mathrm{O}_{1}$ |
| $\mathrm{A}_{8}$ |  | ${ }_{11} 1 / O_{0}$ |
| $\mathrm{A}_{9} \mathrm{~S}$ |  | ${ }_{10}{ }^{\text {A }}$ 14 |
| $\mathrm{A}_{10}$ |  | ${ }^{9} \mathrm{~A}_{13}$ |
| $\mathrm{A}_{11}$ |  | ${ }^{\text {P }} \mathrm{A}_{12}$ |

## Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)
Storage Temperature $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Ambient Temperature with
Power Applied $\qquad$ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Supply Voltage on $\mathrm{V}_{\mathrm{CC}}$ to Relative $\mathrm{GND}^{[2]} \ldots .-0.5 \mathrm{~V}$ to +4.6 V
DC Voltage Applied to Outputs
in High Z State ${ }^{[2]}$ $\qquad$ -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$
DC Input Voltage ${ }^{[2]}$. $\qquad$ -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$

Output Current into Outputs (LOW)............................. 20 mA
Static Discharge Voltage.......................................... >2001V (per MIL-STD-883, Method 3015)
Latch-Up Current................................................... >200 mA
Operating Range

| Range | Ambient <br> Temperature | $\mathbf{V}_{\mathbf{C C}}$ |
| :--- | :---: | :---: |
| Commercial | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $3.3 \mathrm{~V} \pm 300 \mathrm{mV}$ |
| Industrial | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $3.3 \mathrm{~V} \pm 300 \mathrm{mV}$ |

Electrical Characteristics Over the Operating Range ${ }^{[1]}$

| Parameter | Description | Test Conditions |  | 7C1399B-10 |  | 7C1399B-12 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Min. | Max. |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\mathrm{V}_{\mathrm{CC}}=$ Min., $\mathrm{I}_{\mathrm{OH}}=-2.0 \mathrm{~mA}$ |  | 2.4 |  | 2.4 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage | $\mathrm{V}_{\mathrm{CC}}=\mathrm{Min} ., \mathrm{I}_{\mathrm{OL}}=4.0 \mathrm{~mA}$ |  |  | 0.4 |  | 0.4 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage |  |  | 2.2 | $\begin{gathered} \mathrm{V}_{\mathrm{cc}} \\ +0.3 \mathrm{~V} \end{gathered}$ | 2.2 | $\begin{gathered} \mathrm{V}_{\mathrm{cc}} \\ +0.3 \mathrm{~V} \end{gathered}$ | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Input LOW Voltage ${ }^{[2]}$ |  |  | -0.3 | 0.8 | -0.3 | 0.8 | V |
| IIX | Input Load Current |  |  | -1 | +1 | -1 | +1 | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\mathrm{Oz}}$ | Output Leakage Current | $\mathrm{GND} \leq \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{CC}}$, Output Disabled |  | -5 | +5 | -5 | +5 | $\mu \mathrm{A}$ |
| los | Output Short Circuit Current ${ }^{[3]}$ | $\mathrm{V}_{\text {CC }}=$ Max., $\mathrm{V}_{\text {OUT }}=\mathrm{GND}$ |  |  | -300 |  | $-300$ | mA |
| ${ }^{\text {cc }}$ | $\mathrm{V}_{\mathrm{CC}}$ Operating Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{Max} ., \mathrm{I}_{\mathrm{OUT}}=0 \mathrm{~mA}, \\ & \mathrm{f}=\mathrm{f}_{\mathrm{MAX}}=1 / \mathrm{t}_{\mathrm{RC}} \end{aligned}$ |  |  | 60 |  | 55 | mA |
| $\mathrm{I}_{\text {SB1 }}$ | Automatic CE Power-Down Current - TTL Inputs | $\begin{aligned} & \operatorname{Max.} \mathrm{V}_{\mathrm{CC}}, \overline{\mathrm{CE}} \geq \mathrm{V}_{\mathrm{IH}}, \\ & \mathrm{~V}_{\mathrm{IN}} \geq \mathrm{V}_{\mathrm{IH}}, \text { or } \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{IL}}, f=f_{\mathrm{MAX}} \end{aligned}$ |  |  | 5 |  | 5 | mA |
|  |  |  | L |  | 4 |  | 4 | mA |
| $\mathrm{I}_{\text {SB2 }}$ | Automatic CE Power-Down Current - CMOS Inputs ${ }^{[4]}$ | $\begin{aligned} & \text { Max. }^{V_{C C}}, \overline{\mathrm{CE}} \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}} \geq \\ & \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}, \text { or } \mathrm{V}_{\mathrm{IN}} \leq 0.3 \mathrm{~V}, \\ & \mathrm{WE} \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V} \text { or } \mathrm{WE} \leq 0.3 \mathrm{~V}, \\ & \mathrm{f}=\mathrm{f}_{\mathrm{MAX}} \end{aligned}$ |  |  | 500 |  | 500 | $\mu \mathrm{A}$ |
|  |  |  | L |  | 50 |  | 50 | $\mu \mathrm{A}$ |

Notes:
2. Minimum voltage is equal to -2.0 V for pulse durations of less than 20 ns .
3. Not more than one output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.
4. Device draws low standby current regardless of switching on the addresses.

Electrical Characteristics Over the Operating Range (continued)

| Parameter | Description | Test Conditions |  | 1399B-15 |  | 1399B-20 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Min. | Max. |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\mathrm{V}_{\mathrm{CC}}=$ Min., $\mathrm{I}_{\mathrm{OH}}=-2.0 \mathrm{~mA}$ |  | 2.4 |  | 2.4 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage | $\mathrm{V}_{\mathrm{CC}}=\mathrm{Min} ., \mathrm{I}_{\mathrm{OL}}=4.0 \mathrm{~mA}$ |  |  | 0.4 |  | 0.4 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage |  |  | 2.2 | $\begin{gathered} \mathrm{V}_{\mathrm{Cc}} \\ +0.3 \mathrm{~V} \end{gathered}$ | 2.2 | $\begin{gathered} \mathrm{V}_{\mathrm{cc}} \\ +0.3 \mathrm{~V} \end{gathered}$ | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Input LOW Voltage |  |  | -0.3 | 0.8 | -0.3 | 0.8 | V |
| IIX | Input Load Current |  |  | -1 | +1 | -1 | +1 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{OZ}}$ | Output Leakage Current | $\mathrm{GND} \leq \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{CC}}$, Output Disabled |  | -5 | +5 | -5 | +5 | $\mu \mathrm{A}$ |
| Ios | Output Short Circuit Current ${ }^{[3]}$ | $\mathrm{V}_{\mathrm{CC}}=$ Max., $\mathrm{V}_{\text {OUT }}=\mathrm{GND}$ |  |  | -300 |  | -300 | mA |
| $\mathrm{I}_{\mathrm{CC}}$ | $V_{C C}$ Operating Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\text { Max., } \mathrm{I}_{\text {OUT }}=0 \mathrm{~mA}, \\ & \mathrm{f}=\mathrm{f}_{\mathrm{MAX}}=1 / \mathrm{t}_{\mathrm{RC}} \end{aligned}$ |  |  | 50 |  | 45 | mA |
| $\mathrm{I}_{\text {SB1 }}$ | Automatic CE Power-Down Current - TTL Inputs | $\begin{aligned} & \text { Max. } \mathrm{V}_{\mathrm{CC}}, \overline{\mathrm{CE}} \geq \mathrm{V}_{\mathrm{IH}}, \\ & \mathrm{~V}_{\mathrm{IN}} \geq \mathrm{V}_{\mathrm{IH}}, \text { or } \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{IL}}, \\ & \mathrm{f}=\mathrm{f}_{\mathrm{MAX}} \end{aligned}$ |  |  | 5 |  | 5 | mA |
|  |  |  | L |  | 4 |  | 4 | mA |
| $\mathrm{I}_{\text {SB2 }}$ | Automatic CE Power-Down Current - CMOS Inputs ${ }^{[4]}$ | $\begin{aligned} & \text { Max. } \mathrm{V}_{\mathrm{CC}}, \overline{\mathrm{CE}} \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}} \\ & \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}, \text { or } \mathrm{V}_{\mathrm{IN}} \leq 0.3 \mathrm{~V}, \\ & \mathrm{WE} \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V} \text { or } \mathrm{WE} \leq \leq 0.3 \mathrm{~V}, \\ & \mathrm{f}=\mathrm{f}_{\mathrm{MAX}} \end{aligned}$ |  |  | 500 |  | 500 | $\mu \mathrm{A}$ |
|  |  |  | L |  | 50 |  | 50 | $\mu \mathrm{A}$ |

## Capacitance ${ }^{[5]}$

| Parameter | Description | Test Conditions | Max. | Unit |
| :--- | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{IN}}:$ Addresses | Input Capacitance | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ | 5 | pF |
| $\mathrm{C}_{\mathrm{IN}}:$ Controls |  |  | 6 | pF |
| $\mathrm{C}_{\mathrm{OUT}}$ |  |  | 6 | pF |

## AC Test Loads and Waveforms



Note:
5. Tested initially and after any design or process changes that may affect these parameters.

Switching Characteristics Over the Operating Range ${ }^{[6]}$

| Parameter | Description | 1399B-10 |  | 1399B-12 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. | Min. | Max. |  |
| Read Cycle |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{RC}}$ | Read Cycle Time | 10 |  | 12 |  | ns |
| $\mathrm{t}_{\mathrm{AA}}$ | Address to Data Valid |  | 10 |  | 12 | ns |
| $\mathrm{t}_{\mathrm{OHA}}$ | Data Hold from Address Change | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {ACE }}$ | CE LOW to Data Valid |  | 10 |  | 12 | ns |
| $\mathrm{t}_{\text {doe }}$ | OE LOW to Data Valid |  | 5 |  | 5 | ns |
| thzoe | $\overline{\mathrm{OE}}$ LOW to Low $\mathrm{Z}^{[7]}$ | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {Hzoe }}$ | $\overline{\mathrm{OE}} \mathrm{HIGH}$ to High $\mathrm{Z}^{[7,8]}$ |  | 5 |  | 5 | ns |
| tızCE | $\overline{\mathrm{CE}}$ LOW to Low ${ }^{[7]}$ | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {HZCE }}$ | $\overline{\mathrm{CE}}$ HIGH to High $\mathrm{Z}^{[7,8]}$ |  | 5 |  | 6 | ns |
| $\mathrm{t}_{\mathrm{PU}}$ | $\overline{\mathrm{CE}}$ LOW to Power-Up | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {PD }}$ | $\overline{\mathrm{CE}}$ HIGH to Power-Down |  | 10 |  | 12 | ns |
| Write Cycle ${ }^{[9,10]}$ |  |  |  |  |  |  |
| $\mathrm{t}_{\text {wc }}$ | Write Cycle Time | 10 |  | 12 |  | ns |
| $\mathrm{t}_{\text {SCE }}$ | CE LOW to Write End | 8 |  | 8 |  | ns |
| $\mathrm{t}_{\text {AW }}$ | Address Set-Up to Write End | 7 |  | 8 |  | ns |
| $\mathrm{t}_{\mathrm{HA}}$ | Address Hold from Write End | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\mathrm{SA}}$ | Address Set-Up to Write Start | 0 |  | 0 |  | ns |
| $t_{\text {PWE }}$ | WE Pulse Width | 7 |  | 8 |  | ns |
| $\mathrm{t}_{\text {SD }}$ | Data Set-Up to Write End | 5 |  | 7 |  | ns |
| $\mathrm{t}_{\mathrm{HD}}$ | Data Hold from Write End | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {HZWE }}$ | $\overline{\text { WE }}$ LOW to High $Z^{[9]}$ |  | 7 |  | 7 | ns |
| t LZWE | $\overline{\text { WE }}$ HIGH to Low $Z^{[7]}$ | 3 |  | 3 |  | ns |

## Notes:

6. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5 V , input pulse levels of 0 to 3.0 V , and output loading of the specified $\mathrm{l}_{\mathrm{OL}} / \mathrm{I}_{\mathrm{OH}}$ and capacitance $\mathrm{C}_{\mathrm{L}}=30 \mathrm{pF}$.
7. At any given temperature and voltage condition, $t_{\text {HZCE }}$ is less than $t_{\text {LZCE }}, t_{\text {HZOE }}$ is less than $t_{\text {LZOE }}$, and $t_{H Z W E}$ is less than $t_{\text {LZWE }}$ for any given device.
8. $\mathrm{t}_{\mathrm{HZOE}}, \mathrm{t}_{\text {HZCE }}, \mathrm{t}_{\text {HZWE }}$ are specified with $\mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ as in AC Test Loads. Transition is measured $\pm 500 \mathrm{mV}$ from steady state voltage.
9. The internal write time of the memory is defined by the overlap of $\overline{C E}$ LOW and $\overline{W E}$ LOW. Both signals must be LOW to initiate a write and either signal can terminate a write by going HIGH. The data input set-up and hold timing should be referenced to the rising edge of the signal that terminates the write.
10. The minimum write cycle time for write cycle \#3 ( $\overline{\mathrm{WE}}$ controlled, $\overline{\mathrm{OE}} \mathrm{LOW}$ ) is the sum of $\mathrm{t}_{\text {HZWE }}$ and $\mathrm{t}_{\mathrm{SD}}$.

Switching Characteristics Over the Operating Range ${ }^{[6]}$ (continued)

| Parameter | Description | 1399B-15 |  | 1399B-20 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. | Min. | Max. |  |
| Read Cycle |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{RC}}$ | Read Cycle Time | 15 |  | 20 |  | ns |
| $\mathrm{t}_{\mathrm{AA}}$ | Address to Data Valid |  | 15 |  | 20 | ns |
| $\mathrm{t}_{\mathrm{OHA}}$ | Data Hold from Address Change | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {ACE }}$ | $\overline{\mathrm{CE}}$ LOW to Data Valid |  | 15 |  | 20 | ns |
| $\mathrm{t}_{\text {DOE }}$ | $\overline{\mathrm{OE}}$ LOW to Data Valid |  | 6 |  | 7 | ns |
| t Lzoe | $\overline{\mathrm{OE}}$ LOW to Low $\mathrm{Z}^{[7]}$ | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {HZOE }}$ | $\overline{\mathrm{OE}}$ HIGH to High $\mathrm{Z}^{[7,8]}$ |  | 6 |  | 6 | ns |
| t LzCE | $\overline{\mathrm{CE}}$ LOW to Low $\mathrm{Z}^{[7]}$ | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {HZCE }}$ | $\overline{\mathrm{CE}}$ HIGH to High $\mathrm{Z}^{[7,8]}$ |  | 7 |  | 7 | ns |
| $\mathrm{t}_{\mathrm{Pu}}$ | $\overline{\mathrm{CE}}$ LOW to Power-Up | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {PD }}$ | $\overline{\mathrm{CE}}$ HIGH to Power-Down |  | 15 |  | 20 | ns |
| Write Cycle ${ }^{[9,10]}$ |  |  |  |  |  |  |
| $\mathrm{t}_{\text {wc }}$ | Write Cycle Time | 15 |  | 20 |  | ns |
| $\mathrm{t}_{\text {SCE }}$ | $\overline{\mathrm{CE}}$ LOW to Write End | 10 |  | 12 |  | ns |
| $\mathrm{t}_{\text {AW }}$ | Address Set-Up to Write End | 10 |  | 12 |  | ns |
| $\mathrm{t}_{\mathrm{HA}}$ | Address Hold from Write End | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {SA }}$ | Address Set-Up to Write Start | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {PWE }}$ | $\overline{\text { WE Pulse Width }}$ | 10 |  | 12 |  | ns |
| $\mathrm{t}_{\text {SD }}$ | Data Set-Up to Write End | 8 |  | 10 |  | ns |
| $\mathrm{t}_{\mathrm{HD}}$ | Data Hold from Write End | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {HZWE }}$ | $\overline{\text { WE }}$ LOW to High ${ }^{\text {[ }}{ }^{[9]}$ |  | 7 |  | 7 | ns |
| $\mathrm{t}_{\text {LZWE }}$ | $\overline{\text { WE }}$ HIGH to Low ${ }^{\text {[7] }}$ | 3 |  | 3 |  | ns |

Data Retention Characteristics (Over the Operating Range - L version only)

| Parameter | Description | Conditions | Min. | Max. | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DR}}$ | $\mathrm{V}_{\mathrm{CC}}$ for Data Retention |  | 2.0 |  | V |
| $\mathrm{I}_{\mathrm{CCDR}}$ | Data Retention Current | Com'I | $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{DR}}=2.0 \mathrm{~V}$, <br> $\mathrm{CE} \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}$, <br> $\mathrm{V}_{\mathrm{IN}} \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}$ or <br> $\mathrm{V}_{\mathrm{INR}} \leq 0.3 \mathrm{~V}$ | Chip Deselect to Data <br> Retention Time |  |
|  | Operation Recovery Time | 0 | 20 | $\mu \mathrm{~A}$ |  |
| $\mathrm{t}_{\mathrm{R}}$ |  | $\mathrm{t}_{\mathrm{RC}}$ | ns |  |  |

## Data Retention Waveform



## Switching Waveforms

Read Cycle No. 1 ${ }^{[11,12]}$


Read Cycle No. ${ }^{[12,13]}$


## Notes:

11. Device is continuously selected. $\overline{\mathrm{OE}}, \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}$.
12. WE is HIGH for read cycle.
13. Address valid prior to or coincident with $\overline{\mathrm{CE}}$ transition LOW.

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## Switching Waveforms (continued)

Write Cycle No. 1 ( $\overline{\text { WE }}$ Controlled) ${ }^{[9,14,15]}$


Write Cycle No. 2 ( $\overline{\text { CE Controlled }})^{[9,14,15]}$


Write Cycle No. 3 ( $\overline{\mathrm{WE}}$ Controlled, $\overline{\mathrm{OE}} \mathrm{LOW})^{[10,15]}$


## Notes:

14. Data $I / O$ is high impedance if $\overline{O E}=V_{I H}$.
15. If $\overline{C E}$ goes HIGH simultaneously with WE HIGH, the output remains in a high-impedance state.
16. During this period, the I/Os are in the output state and input signals should not be applied.

## Truth Table

| $\overline{\mathbf{C E}}$ | $\overline{\mathbf{W E}}$ | $\overline{\mathrm{OE}}$ | Input/Output | Mode | Power |
| :---: | :---: | :---: | :--- | :--- | :--- |
| H | X | X | High Z | Deselect/Power-Down | Standby ( $\left.\mathrm{I}_{\mathrm{SB}}\right)$ |
| L | H | L | Data Out | Read | Active ( $\left.\mathrm{I}_{\mathrm{CC}}\right)$ |
| L | L | X | Data In | Write | Active ( $\left.\mathrm{I}_{\mathrm{CC}}\right)$ |
| L | H | H | High Z | Deselect, Output Disabled | Active ( $\left.\mathrm{I}_{\mathrm{CC}}\right)$ |

## Ordering Information

| $\begin{gathered} \text { Speed } \\ \text { (ns) } \end{gathered}$ | Ordering Code | Package Name | Package Type | Operating Range |
| :---: | :---: | :---: | :---: | :---: |
| 12 | CY7C1399B-12VC | V21 | 28-Lead Molded SOJ | Commercial |
|  | CY7C1399B-12VXC | V21 | 28-Lead Molded SOJ (Pb-Free) |  |
|  | CY7C1399B-12ZC | Z28 | 28-Lead Thin Small Outline Package |  |
|  | CY7C1399B-12ZXC | Z28 | 28-Lead Thin Small Outline Package (Pb-Free) |  |
|  | CY7C1399BL-12ZC | Z28 | 28-Lead Thin Small Outline Package |  |
|  | CY7C1399BL-12ZXC | Z28 | 28-Lead Thin Small Outline Package (Pb-Free) |  |
|  | CY7C1399B-12VXI | V21 | 28-Lead Molded SOJ (Pb-Free) | Industrial |
| 15 | CY7C1399B-15VC | V21 | 28-Lead Molded SOJ | Commercial |
|  | CY7C1399B-15VXC | V21 | 28-Lead Molded SOJ (Pb-Free) |  |
|  | CY7C1399B-15ZC | Z28 | 28-Lead Thin Small Outline Package |  |
|  | CY7C1399B-15ZXC | Z28 | 28-Lead Thin Small Outline Package (Pb-Free) |  |
|  | CY7C1399BL-15VC | V21 | 28-Lead Molded SOJ |  |
|  | CY7C1399BL-15VXC | V21 | 28-Lead Molded SOJ (Pb-Free) |  |
|  | CY7C1399BL-15ZXC | Z28 | 28-Lead Thin Small Outline Package (Pb-Free) |  |
|  | CY7C1399B-15VI | V21 | 28-Lead Molded SOJ | Industrial |
|  | CY7C1399B-15VXI | V21 | 28-Lead Molded SOJ (Pb-Free) |  |
|  | CY7C1399B-15ZI | Z28 | 28-Lead Thin Small Outline Package |  |
|  | CY7C1399B-15ZXI | Z28 | 28-Lead Thin Small Outline Package (Pb-Free) |  |
| 20 | CY7C1399B-20ZC | Z28 | 28-Lead Thin Small Outline Package | Commercial |
|  | CY7C1399B-20ZXC | Z28 | 28-Lead Thin Small Outline Package (Pb-Free) |  |

## Package Diagrams

## 28-Lead (300-Mil) Molded SOJ V21

DIMENSIONS IN INCHES
MIN. MAX.


DETAIL A EXTERNAL LEAD DESIGN


OPTION 1


51-85031-*B
28-Lead Thin Small Outline Package Type 1 ( $8 \times 13.4 \mathrm{~mm}$ ) Z28

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NQTE: \(\square R I E N T A T I D N\) I.D MAY BE LQCATED EITHER AS SHOWN IN पPTIUN I पR UPTIUN 2
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CY7C1399B

## Document History Page

Document Title: CY7C1399B 256K(32K x 8) Static RAM
Document Number: 38-05071

| REV. | ECN NO. | ISSUE <br> DATE | ORIG. OF <br> CHANGE | DESCRIPTION OF CHANGE |
| :---: | :---: | :---: | :---: | :--- |
| $* *$ | 107264 | $05 / 25 / 01$ | SZV | Change from Spec \#: 38-01102 to 38-05071 |
| *A | 107533 | $06 / 28 / 01$ | MAX | Add Low Power |
| *B | 116472 | $09 / 17 / 02$ | CEA | Add applications foot note to data sheet, page 1. |
| $* C$ | 224340 | See ECN | RKF | Option 1 of the Orientation ID on TSOP-I Package Diagram [Page \#9] <br> removed |
| *D | 386100 | See ECN | SYT | Converted the Datasheet from "Preliminary" to "Final" <br> Added Pb-Free offerings in the Ordering Information <br> Edited the title to "256K (32K x 8) Static RAM" from "32K x 8 3.3V Static RAM" |

